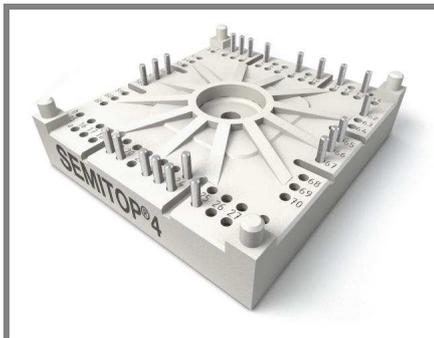


# SK100GH12T4T



**SEMITOP®4**

IGBT module

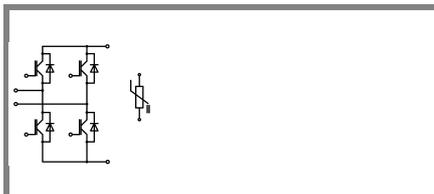
SK100GH12T4T

## Features

- One screw mounting module
- Fully compatible with SEMITOP®1,2,3
- Improved thermal performances by aluminium oxide substrate
- New IGBT4 Technology
- CAL 4 technology FWD
- Integrated NTC Temperature sensor

## Typical Applications\*

- Voltage regulator

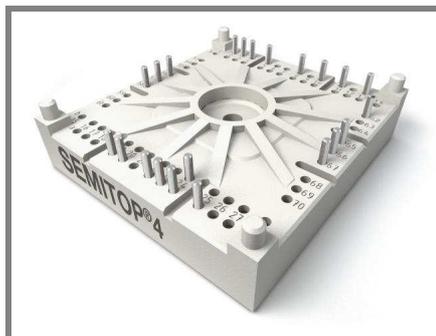


GH-T

Absolute Maximum Ratings		$T_s = 25\text{ °C}$ , unless otherwise specified	
Symbol	Conditions	Values	Units
<b>IGBT</b>			
$V_{CES}$	$T_j = 25\text{ °C}$	1200	V
$I_C$	$T_j = 175\text{ °C}$	$T_s = 25\text{ °C}$	126 A
		$T_s = 70\text{ °C}$	100 A
$I_{CRM}$	$I_{CRM} = 3 \times I_{Cnom}$ , $t_p \leq 1\text{ ms}$	300	A
$V_{GES}$		$\pm 20$	V
$t_{psc}$	$V_{CC} = 800\text{ V}$ ; $V_{GE} \leq 15\text{ V}$ ; $T_j = 150\text{ °C}$ $V_{CES} < 1200\text{ V}$	10	$\mu\text{s}$
<b>Inverse Diode</b>			
$I_F$	$T_j = 175\text{ °C}$	$T_s = 25\text{ °C}$	102 A
		$T_s = 70\text{ °C}$	81 A
$I_{FRM}$	$I_{FRM} = 3 \times I_{Fnom}$ , $t_p \leq 1\text{ ms}$	300	A
$I_{FSM}$	$t_p = 10\text{ ms}$ ; half sine wave $T_j = 150\text{ °C}$	715	A
<b>Module</b>			
$I_{t(RMS)}$			A
$T_{vj}$		-40 ... +175	$^{\circ}\text{C}$
$T_{stg}$		-40 ... +125	$^{\circ}\text{C}$
$V_{isol}$	AC, 1 min.	2500	V

Characteristics		$T_c = 25\text{ °C}$ , unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
<b>IGBT</b>					
$V_{GE(th)}$	$V_{GE} = V_{CE}$ , $I_C = 3,4\text{ mA}$	5	5,8	6,5	V
$I_{CES}$	$V_{GE} = 0\text{ V}$ , $V_{CE} = V_{CES}$	$T_j = 25\text{ °C}$		1,68	mA
		$T_j = 125\text{ °C}$	0,4		mA
$I_{GES}$	$V_{CE} = 0\text{ V}$ , $V_{GE} = 20\text{ V}$			1200	nA
$V_{CE0}$		$T_j = 25\text{ °C}$	0,8	0,9	V
		$T_j = 150\text{ °C}$	0,7	0,8	V
$r_{CE}$	$V_{GE} = 15\text{ V}$	$T_j = 25\text{ °C}$	10		m $\Omega$
		$T_j = 150\text{ °C}$	15		m $\Omega$
$V_{CE(sat)}$	$I_{Cnom} = 100\text{ A}$ , $V_{GE} = 15\text{ V}$	$T_j = 25\text{ °C}_{chiplev.}$	1,8	2	V
		$T_j = 150\text{ °C}_{chiplev.}$	2,2	2,4	V
$C_{ies}$	$V_{CE} = 25$ , $V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	5,54		nF
$C_{oes}$			0,41		nF
$C_{res}$			0,32		nF
$Q_G$	$V_{GE} = -7\text{ V} \dots +15\text{ V}$		750		nC
$R_{Gint}$	$T_j = 25\text{ °C}$		2		$\Omega$
$t_{d(on)}$	$R_{Gon} = 16\text{ }\Omega$ $di/dt = 1800\text{ A}/\mu\text{s}$	$V_{CC} = 600\text{ V}$ $I_C = 100\text{ A}$ $T_j = 150\text{ °C}$	63		ns
$t_r$			65		ns
$E_{on}$			16,6		mJ
$t_{d(off)}$	$R_{Goff} = 16\text{ }\Omega$ $di/dt = 1800\text{ A}/\mu\text{s}$		521		ns
$t_f$			80		ns
$E_{off}$			10		mJ
$R_{th(j-s)}$	per IGBT		0,43		K/W

# SK100GH12T4T



**SEMITOP®4**

IGBT module

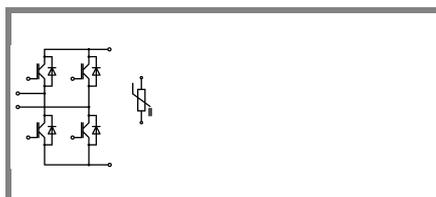
SK100GH12T4T

## Features

- One screw mounting module
- Fully compatible with SEMITOP®1,2,3
- Improved thermal performances by aluminium oxide substrate
- New IGBT4 Technology
- CAL 4 technology FWD
- Integrated NTC Temperature sensor

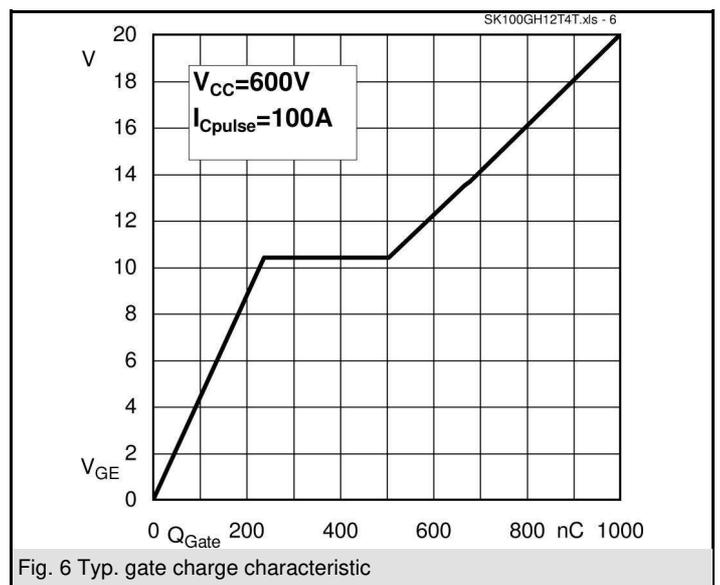
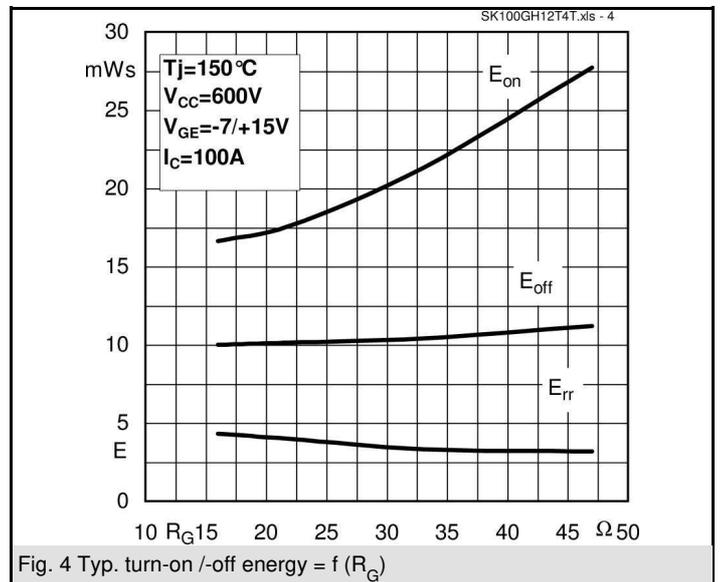
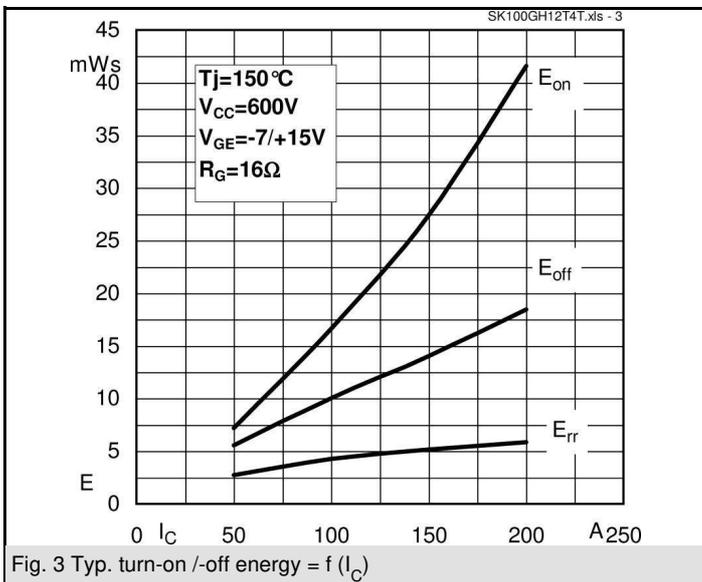
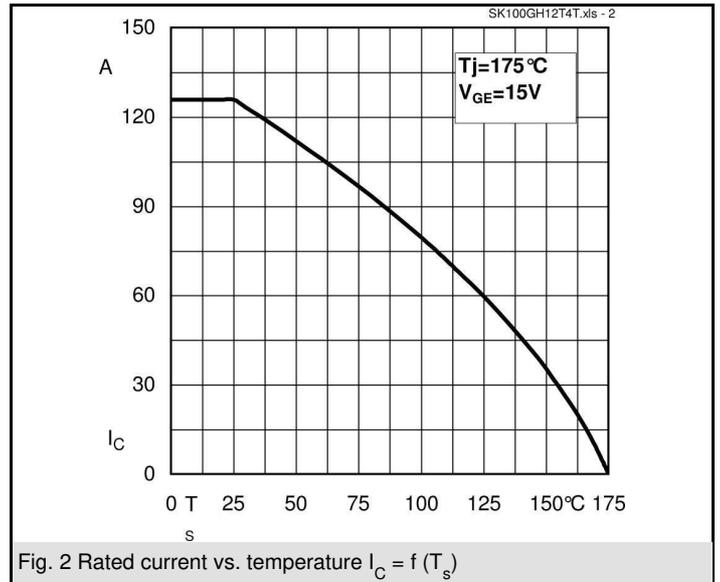
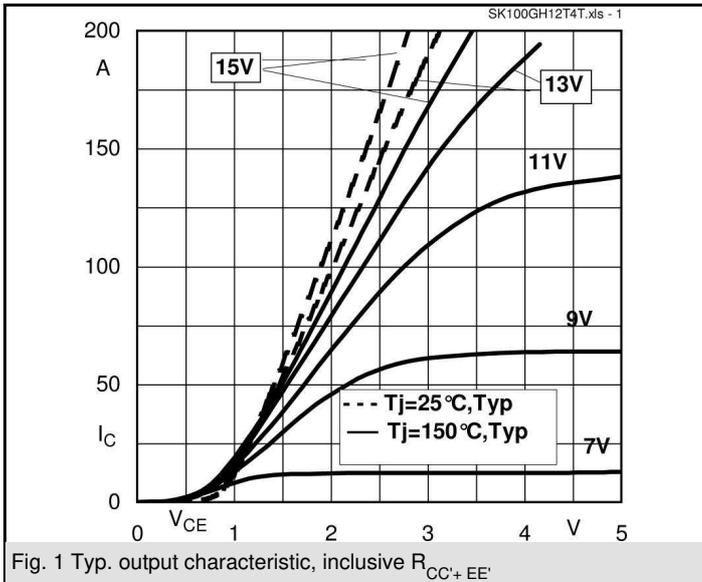
## Typical Applications\*

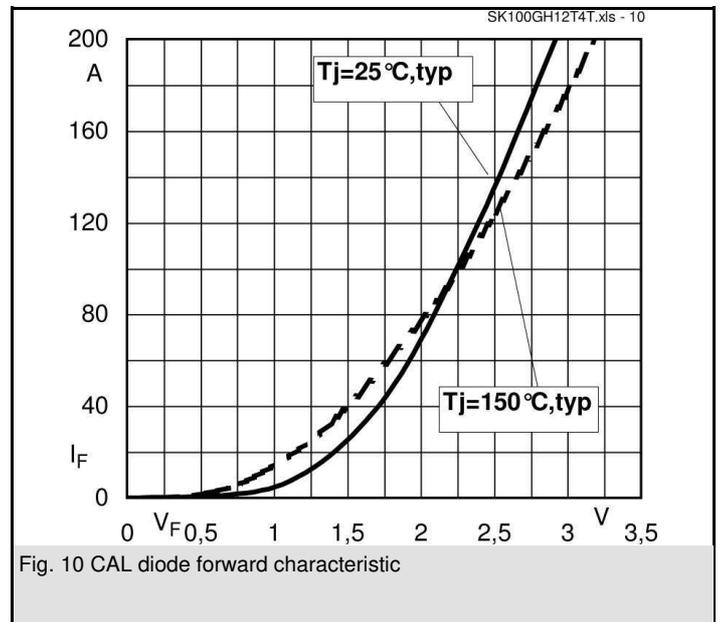
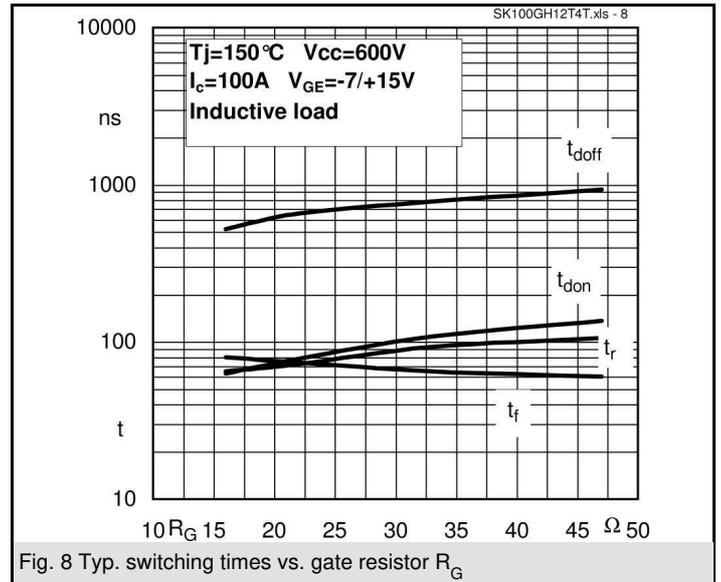
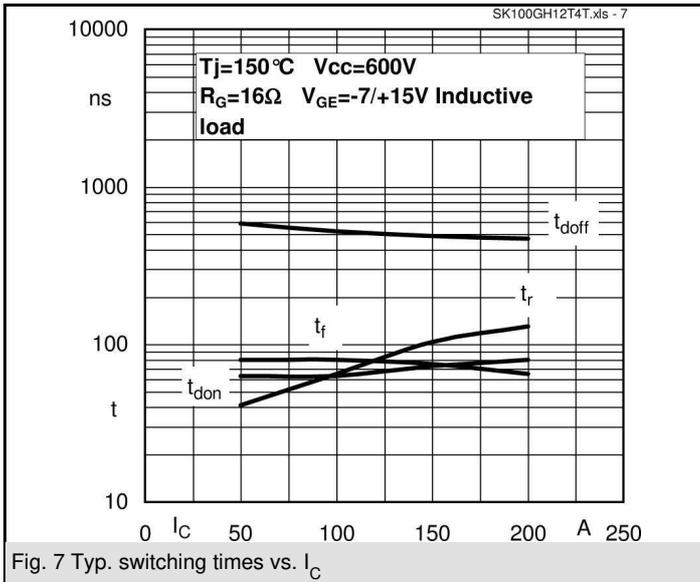
- Voltage regulator



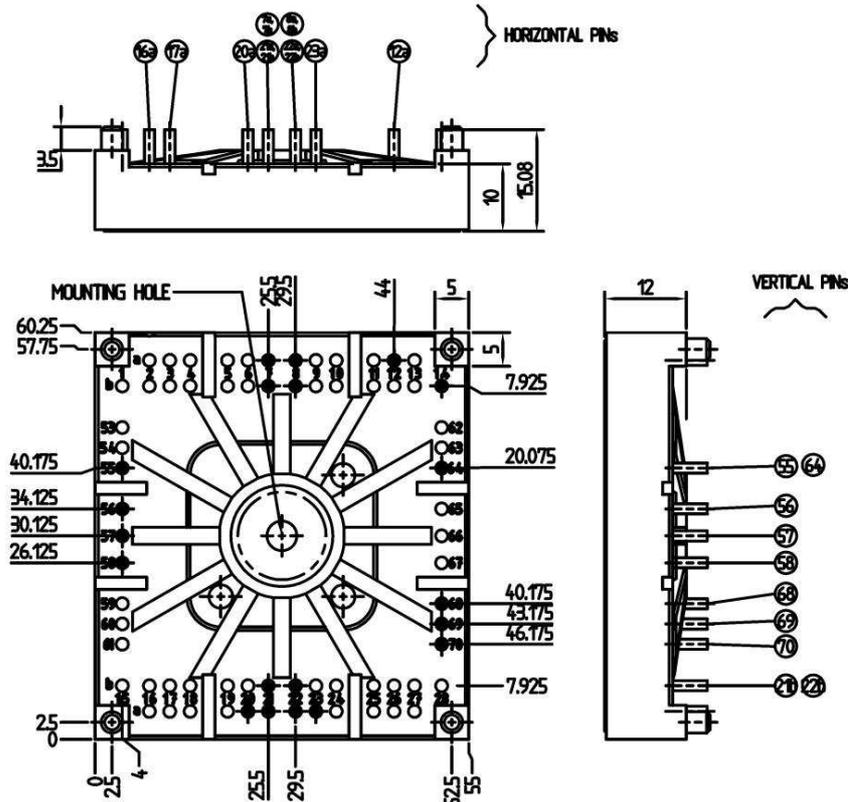
GH-T

Characteristics				min.	typ.	max.	Units
Symbol	Conditions						
<b>Inverse Diode</b>							
$V_F = V_{EC}$	$I_{Fnom} = 100 \text{ A}; V_{GE} = 0 \text{ V}$	$T_j = 25 \text{ }^\circ\text{C}_{\text{chiplev.}}$		2,2	2,5		V
		$T_j = 150 \text{ }^\circ\text{C}_{\text{chiplev.}}$		2,1	2,45		V
$V_{F0}$		$T_j = 25 \text{ }^\circ\text{C}$		1,3	1,5		V
		$T_j = 150 \text{ }^\circ\text{C}$		0,9	1,1		V
$r_F$		$T_j = 25 \text{ }^\circ\text{C}$		9,5	10,5		mΩ
		$T_j = 150 \text{ }^\circ\text{C}$		13	14		mΩ
$I_{RRM}$	$I_F = 100 \text{ A}$	$T_j = 150 \text{ }^\circ\text{C}$		52			A
$Q_{rr}$	$di/dt = 1800 \text{ A}/\mu\text{s}$			14			μC
$E_{rr}$	$V_{CC} = 600 \text{ V}$			5,2			mJ
$R_{th(j-s)D}$	per diode			0,62			K/W
<b>Freewheeling Diode</b>							
$V_F = V_{EC}$	$I_{Fnom} = \text{A}; V_{GE} = \text{V}$	$T_j = \text{ }^\circ\text{C}_{\text{chiplev.}}$					V
$V_{F0}$		$T_j = \text{ }^\circ\text{C}$					V
$r_F$		$T_j = \text{ }^\circ\text{C}$					V
$I_{RRM}$	$I_F = \text{A}$	$T_j = \text{ }^\circ\text{C}$					A
$Q_{rr}$							μC
$E_{rr}$							mJ
	per diode						K/W
$M_s$	to heat sink			2,5	2,75		Nm
w				60			g
<b>Temperature sensor</b>							
$R_{100}$	$T_s = 100^\circ\text{C} (R_{25} = 5\text{k}\Omega)$			493±5%			Ω

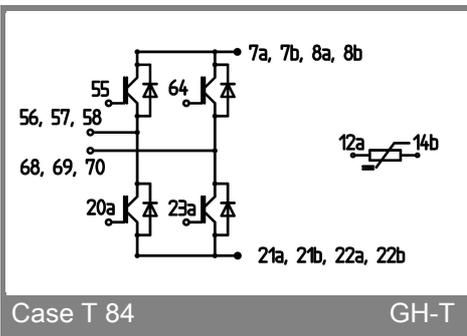




# SK100GH12T4T



Case T84 (Suggested hole diameter, in the PCB, for solder pins and plastic mounting pins: 2mm)



Case T 84

GH-T

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

## \*IMPORTANT INFORMATION AND WARNINGS

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